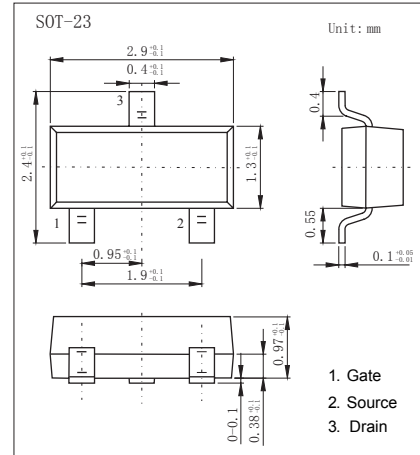
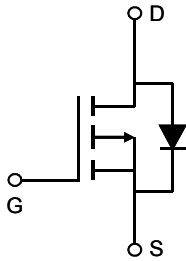


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■ Features

- $V_{DS} = -20V$
- $I_D = -3 A$ ($V_{GS} = -4.5V$)
- $R_{DS(ON)} < 80m\Omega$ ($V_{GS} = -4.5V$)
- $R_{DS(ON)} < 100m\Omega$ ($V_{GS} = -2.5V$)
- $R_{DS(ON)} < 130m\Omega$ ($V_{GS} = -1.8V$)



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	± 8	
Continuous Drain Current	$T_a = 25^\circ C$	I_D	-3	A
	$T_a = 70^\circ C$		-2.4	
Pulsed Drain Current		I_{DM}	-15	
Power Dissipation	$T_a = 25^\circ C$	P_D	1.4	W
	$T_a = 70^\circ C$		0.9	
Thermal Resistance.Junction- to-Ambient	$t \leq 10s$	R_{thJA}	90	$^\circ C/W$
	Steady-State		125	
Thermal Resistance.Junction- to-Lead		R_{thJL}	80	
Junction Temperature		T_J	150	$^\circ C$
Junction Storage Temperature Range		T_{stg}	-55 to 150	

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■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =-250 μ A, V _{GS} =0V	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V			-1	μA
		V _{DS} =-20V, V _{GS} =0V, T _J =55°C			-5	
Gate-Body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±8V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =-250 μ A	-0.4		-1	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-3A			80	mΩ
		V _{GS} =-4.5V, I _D =-3A T _J =125°C			115	
		V _{GS} =-2.5V, I _D =-2.6A			100	
		V _{GS} =-1.8V, I _D =-1A			130	
On state drain current	I _{D(ON)}	V _{GS} =-4.5V, V _{DS} =-5V	-15			A
Forward Transconductance	g _{FS}	V _{DS} =-5V, I _D =-3A		12		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =-10V, f=1MHz		560	745	pF
Output Capacitance	C _{oss}			80		
Reverse Transfer Capacitance	C _{rss}			70		
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1MHz		15	23	Ω
Total Gate Charge	Q _g	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-3A		8.5	11	nC
Gate Source Charge	Q _{gs}			1.2		
Gate Drain Charge	Q _{gd}			2.1		
Turn-On DelayTime	t _{d(on)}	V _{GS} =-4.5V, V _{DS} =-10V, R _L =3.3Ω, R _{GEN} =6Ω		7.2		ns
Turn-On Rise Time	t _r			36		
Turn-Off DelayTime	t _{d(off)}			53		
Turn-Off Fall Time	t _f			56		
Body Diode Reverse Recovery Time	t _{rr}	I _F =-3A, di/dt=100A/μ s		37	49	nC
Body Diode Reverse Recovery Charge	Q _{rr}			27		
Maximum Body-Diode Continuous Current	I _S				-1.4	A
Diode Forward Voltage	V _{SD}	I _S =-1A, V _{GS} =0V			-1	V

* The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

■ Marking

Marking	AD*
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Typical Characteristics

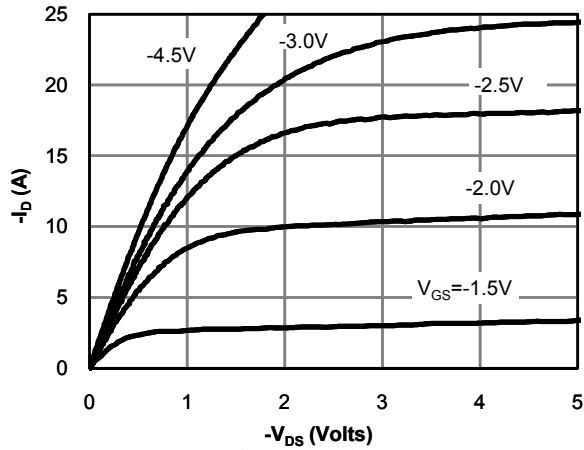


Figure 1: On-Region Characteristics

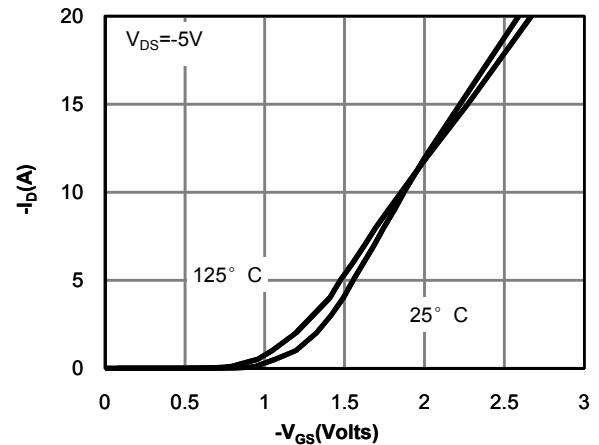


Figure 2: Transfer Characteristics

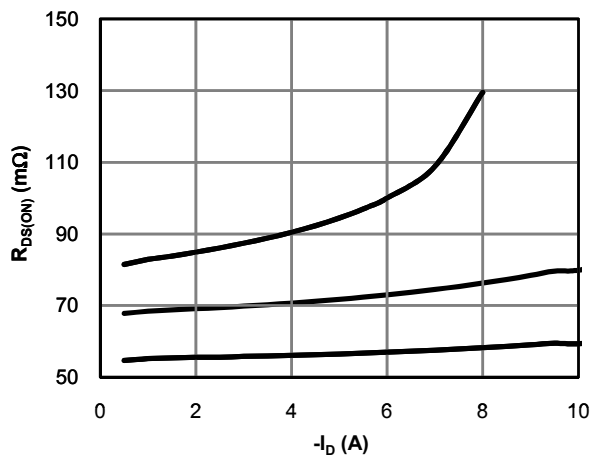


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

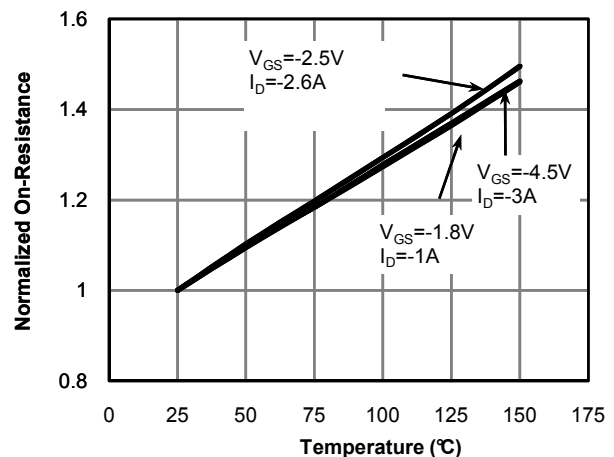


Figure 4: On-Resistance vs. Junction Temperature

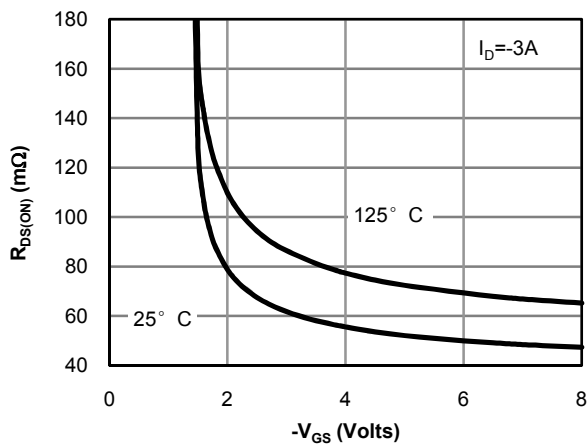


Figure 5: On-Resistance vs. Gate-Source Voltage

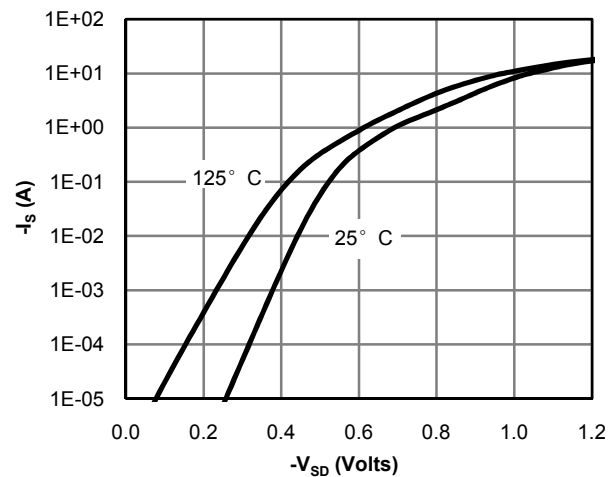


Figure 6: Body-Diode Characteristics

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Typical Characteristics

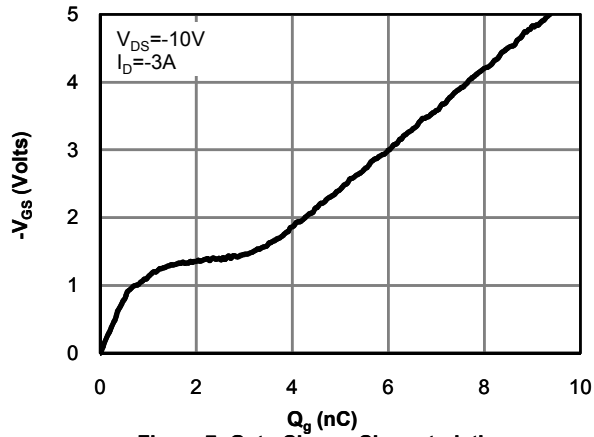


Figure 7: Gate-Charge Characteristics

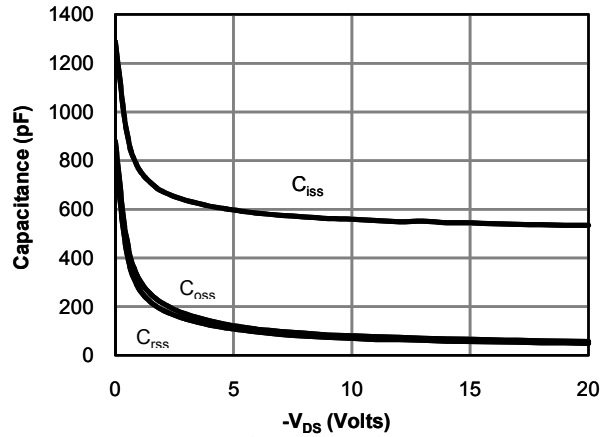


Figure 8: Capacitance Characteristics

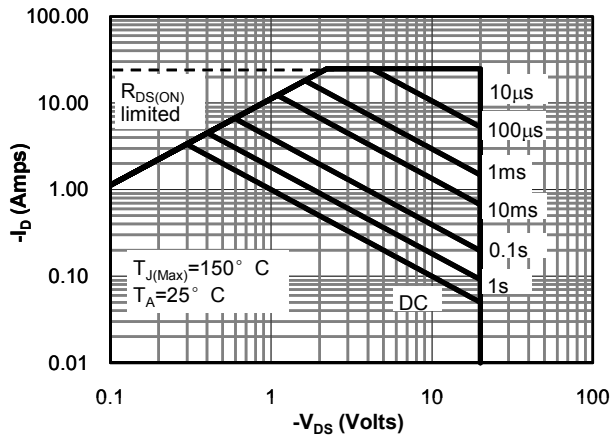


Figure 9: Maximum Forward Biased Safe Operating Area

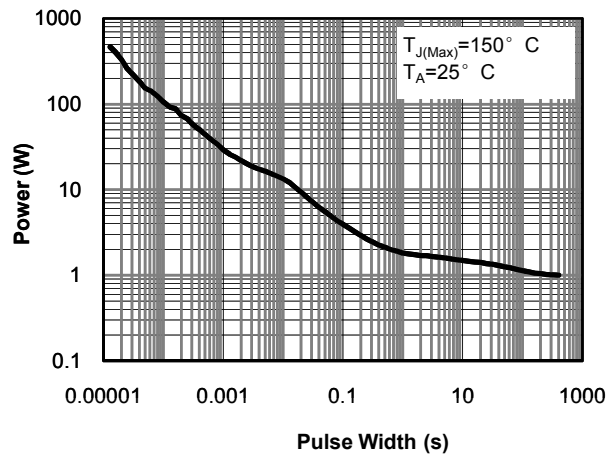


Figure 10: Single Pulse Power Rating Junction-to-Ambient

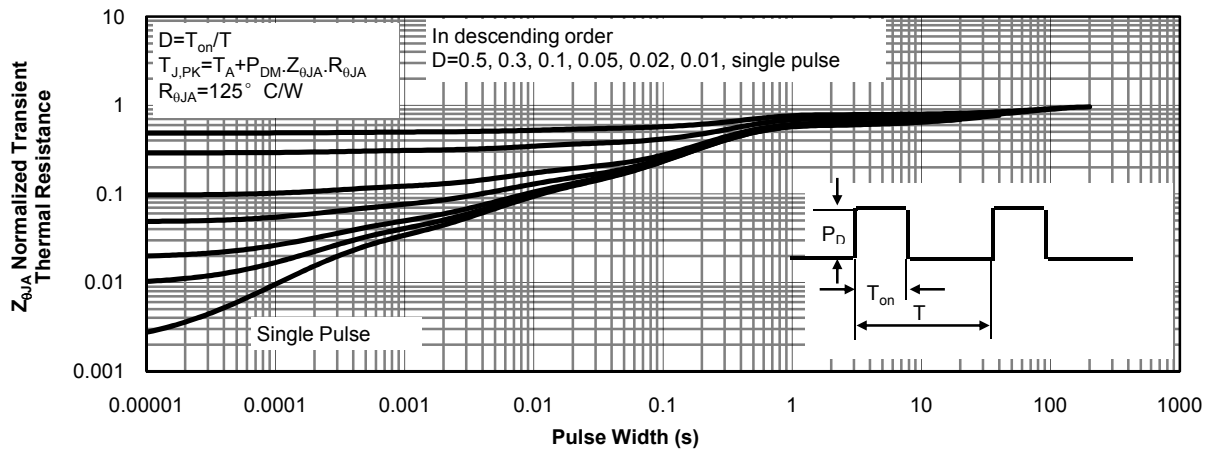


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)